



-30. -40

(1.07)

.042 DIA



ZA8-20-1-1.00-Z-10-2



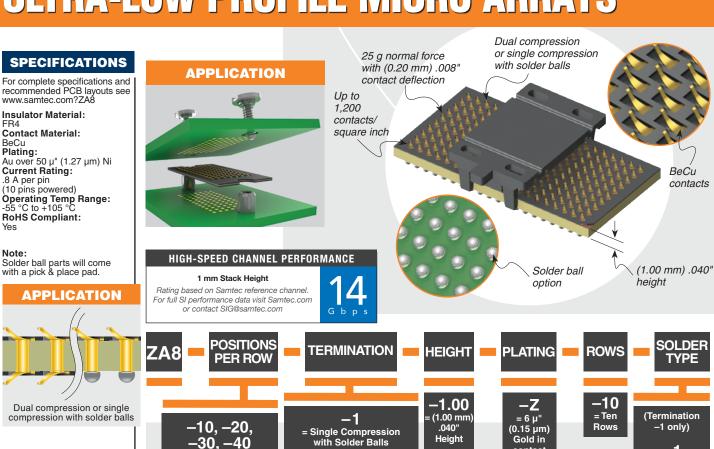
ZA8-30-2-1.00-Z-10

(0.80 mm) .0315"

ZA8 SERIES

ZA8-10-2-1.00-Z-10

ULTRA-LOW PROFILE MICRO ARRAYS



(-10 & -20 positions only)

-2

= Dual Compression

(-10, -20, -30

40 positions only)

- (4.00) .157

(2.00) .079 DIA

40 X 10 DUAL COMPRESSION BOTH SIDES

DESIGN FLEXIBILITY

The Z-Ray® platform is highly-customizable:

Some lengths, styles and

options are non-standard, non-returnable.

PITCH	≥ 0.65 mm
STACK HEIGHT	0.50 mm to 4.00 mm
DENSITY	Up to 1,200 contacts/square inch
RUGGEDIZING	Latches, Thermal Spreaders, Quick-release Spring Constraints
CONSTRUCTION	Multi-layer FR4 (e.g., Pitch Spreaders)

→ (0.80) .0315

(0.80) .0315

20 X 10 COMPRESSION WITH SOLDER BALLS

(1.06)

Height

DIA

10 x 10 COMPRESSION WITH SOLDER BALLS

		(1.00)
-	A	→ → ←
1000		
(9.00)		
<u>*</u>	<i>33333333</i>	1 T

- 1

= Lead

-2

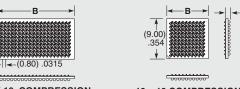
= Lead-Free

Gold in

contact

area

20 x 10 DUAL COMPRESSION



Α	В
(12.50) .492	(9.35) .368
(20.50) .807	(17.35) .683
(31.70) 1.248	N/A
(39.70) 1.563	N/A
	(12.50) .492 (20.50) .807 (31.70) 1.248 (39.70)